



1U PCI Express rIOM Riser and rIOM Carrier Board Kit AXXKPTPIOM

Specifications	⌵
Essentials	
Compatible Products	⌵
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Specifications	
Essentials	
Status	Launched
Launch Date	Q4'14
Included Items	(1) PCI Express x16 (200 pin) rIOM riser, and (1) rIOM carrier board
Description	1x16 PCI Express Gen 3 (200 pin) rIOM riser and rIOM carrier board kit supporting the Intel I/O module for Intel® Compute Module HNS2600KP and Intel® Compute Module HNS2600TP families for Slot 2
Recommended Customer Price	N/A

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PCN/MDDS Information
935524: PCN   MDDS

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

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